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## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :

STEPHANE POCAS, ET AL. : EXAMINER: JONES, ERIC W.

SERIAL NO: 10/584,052 :

FILED: JUNE 22, 2006 : GROUP ART UNIT: 2892

FOR: METHOD OF SEALING TWO PLATES WITH THE FORMATION OF AN OHMIC CONTACT THERE BETWEEN

## RESPONSE TO RESTRICTION REQUIREMENT

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Restriction Requirement dated December 1, 2008, Applicants elect Group I, Claims 1-19, 27-45 and 53-57 directed to a method for the sealing processing for two wafers made of semiconducting materials. Applicants make this election based on the understanding that Applicant is not prejudiced against filing one or more divisional applications that cover the non-elected invention.

Accordingly, it is respectfully requested that a full examination on the merits of Claims 1-19, 27-45 and 53-57 be conducted.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

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